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Title of Invention	BONDING PAD AND CHIP STRUCTURE
Application Number	:
Date :	
First Named Applica	nt: Mr. Chiu-Shun Lin
Confirmation Number	er:
Attorney Docket Nu	nber: 13689-US-PA

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Submitted By:	Elec. Sign.	Sign. Capacity
Dr. Belinda Lee	/Belinda Lee/	Agent
Registered Number: 46863		

Documents being submitted:	Files
us-assignment	13689-usassn.xml
	us-assignment.xsl
	us-assignment.dtd
	13689assignment01.tif
	13689assignment02.tif
us-request	13689-usrequ.xml
	us-request.dtd
	us-request.xsl
us-fee-sheet	13689-usfees.xml
	us-fee-sheet.xsl
	us-fee-sheet.dtd
us-declaration	13689declaration01.tif
application-body	13689usf.xml
	application-body.dtd
	Image1.tif
	Image2.tif
	Image3.tif
	Image4.tif
	isoamsa.ent
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	isoamsc.ent
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	isoamsr.ent
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	isonum.ent
	isopub.ent
	isotech.ent
	mathml2.dtd
	mathml2-qname-1.mod
	mmlalias.ent
	mmlextra.ent
	soextblx.dtd
	us-application-body.xsl
	wipo.ent
application-body-pdf-wrap	13689usf-pdf-wrap.xml
abstract-pdf	13689usf-abst.pdf
<u> </u>	·

claims-pdf	13689usf-clms.pdf	
description-pdf	13689usf-desc.pdf	
drawings-pdf	13689usf-draw.pdf	
us-declaration	13689declaration02.tif	

Comments

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